A light sensor substrate comprises a base made from a semi-conductive material and topped with a layer of an electrically non-conductive material. A first electrode and a plurality of carbon nanotube (CNT)-based conductors are positioned on the layer of electrically non-conductive material with the CNT-based conductors being distributed in a spaced apart fashion about a periphery of the first electrode. Each CNT-based conductor is coupled to one end thereof to the first electrode and extends away from the first electrode to terminate at a second free end. A second or gate electrode is positioned on the non-conductive material layer and is spaced apart from the second free end of each CNT-based conductor. Coupled to the first and second electrode is a device for detecting electron transfer along the CNT-based conductors resulting from light impinging on the CNT-based conductors.
FIG. 1
FIG. 2
Assembly Prepared for Processing

Deposit CNT Attraction Material

Apply Electric Field

Wet with Carrier Liquid Having CNTs in Suspension

Remove Carrier Liquid and Excess CNTs

Wet, Vibrate and Blow Dry to Assure Removal of any residual CNTs

FIG. 4
CARBON NANOTUBE BASED LIGHT SENSOR

ORIGIN OF THE INVENTION

The invention described herein was made in the performance of work under NASA contract number NAS1-00135 and by employees of the United States Government and is subject to the provisions of Section 305 of the National Aeronautics and Space Act of 1958, as amended, Public Law 85-566 (72 Stat. 435; 42 U.S.C. § 2457) and 35 U.S.C. § 202, and may be manufactured and used by or for the Government for governmental purposes without the payment of any royalties thereon or therefore. In accordance with 35 U.S.C. § 202, the contractor elected not to retain title.

RELATED FIELD

This embodiment relates to light sensors. More specifically, the embodiment is a carbon nanotube-based light sensor.

SUMMARY OF THE EMBODIMENT OF THE INVENTION

A light sensor has a substrate defined by a base made from a semi-conductive material and a layer of an electrically non-conductive material on a surface of the base. A first electrode and a plurality of carbon nanotube (CNT)-based conductors are on the layer of electrically non-conductive material. The CNT-based conductors are distributed in a spaced apart fashion about a periphery of the first electrode with each CNT-based conductor being coupled on one end thereof to the first electrode and extending substantially perpendicularly away from the first electrode to terminate at a second end thereof. Each CNT-based conductor comprises at least one CNT. A second electrode on the layer of electrically non-conductive material is positioned to be spaced apart from the second end of each of CNT-based conductor. Coupled to the first and second electrode is a device for detecting a quantity indicative of electron transfer along the CNT-based conductors. Such electron transfer is indicative of an amount of light impinging on the CNT-based conductors.

BRIEF DESCRIPTION OF THE DRAWINGS

FIG. 1 is a side schematic view of a carbon nanotube (CNT)-based light sensor in accordance with an embodiment of the present invention;

FIG. 2 is a schematic view of an apparatus used in the deposition and alignment of CNTs in accordance with an embodiment of the present invention;

FIG. 3 is a perspective view of a portion of the apparatus in FIG. 2 depicting the CNT attraction material and CNTs deposited and aligned between the electrodes of the apparatus in accordance with an embodiment of the present invention;

FIG. 4 schematically depicts the sequence of steps and results achieved thereby during the deposition and alignment of CNTs in accordance with the present invention;

FIG. 5 is a perspective view of a portion of the apparatus in FIG. 2 depicting the CNT attraction material with the CNTs being deposited and aligned on and between the electrodes of the apparatus in accordance with another embodiment of the present invention.

DETAILED DESCRIPTION

Referring now to the drawings, and more particularly to FIG. 1, a light sensor in accordance with one embodiment of the present invention is illustrated schematically and is referenced generally by numeral 10. The light sensor 10 is shown and will be described herein for purposes of demonstrating the concepts of the present embodiment. However, the particular structure and construction of light sensor 10 can be achieved in a variety of ways without departing from the scope of the present invention.

Light sensor 10 comprises a substrate 12 comprising a semiconductor base 15 and an insulating, non-electrically-conducting layer 17 on a surface of base 15. Typically, semiconductor base 15 is an n-type or p-type silicon-based semiconductor material, such as silicon doped with one or more impurities that give the crystal material extra electrons (i.e., n-type) or an electron deficiency (i.e., p-type) as is well known in the art. However, an embodiment could also use other semiconductor materials, e.g., flexible semiconducting polymers. Insulating layer 17 is typically silicon dioxide when semiconductor base 15 is an n-type or p-type silicon-based semiconductor material. Other non-electrically conductive materials, such as silicon nitride, diamond-like carbon, etc., could also be used without departing from the scope of the present invention.

Positioned on insulating layer 17 is at least one alignment (or first) electrode 20 with a number of carbon nanotube (CNT)-based conductors 31 coupled on one end thereof to electrode 20 and extending from electrode 20 to a second free end 31B. Such positioning could be realized by, for example, depositing the electrode and CNTs directly on layer 17, adhering the electrode and CNTs to layer 17 by means of an adhesive (not shown) interposed therebetween, or otherwise coupling the electrode and CNTs to layer 17 for support thereby.

In general, alignment electrode 20 can be any size or shape that allows CNT-based conductors 31 to extend from electrode 20 while remaining spaced apart from one another as will be explained further below. Each of CNT-based conductors 31 can be defined by a single CNT 32 or multiple CNTs 32 that are coupled to one another in an end-to-end fashion to define an electrically-conductive path. CNTs 32 can be single or multi-wall CNTs with single-wall CNTs being preferred because of their smaller diameter, which serves to increase the chances of establishing and maintaining the spaced-apart relationship between CNT-based conductors 31.

Spaced apart from each free end 31B of CNT-based conductors 31 is a gate (or second) electrode 28 positioned on insulating layer 17. An electron transfer measurement device 36 coupled to electrodes 20 and 28 measures a quantity indicative of the amount of electrons being trans-
A CNT attraction material can include any material that suitably attracts and adheres CNTs thereto. Such a material can have an amino-terminated surface that will form a suitable attraction base, and can further be deposited on and adhere to the CNT attraction material. For example, amino-terminated moieties can be spin coated with a resist material (e.g., poly(methylmethacrylate) or PMMA, polymethylglutarimide, etc.) and then patterned with an electron beam to form the desired “receive” location(s) (e.g., gap 24). After cleaning (e.g., in an oxygen plasma), CNT attraction material 30 is deposited on the surface of apparatus 310. The resist material (as well as the portion of CNT attraction material 30 deposited thereon) is then removed (e.g., using standard cleaning procedures) thereby leaving CNT attraction material only in the receive location(s) such as gap 24. CNT attraction material 30 can be any material that suitably attracts and adheres CNTs thereto. Such a material can have an amino-terminated surface that will form a hydrogen bond with one or more hydrogen molecules found on the sidewall of a CNT. Accordingly, CNT attraction material 30 can be a monolayer material such as a self-assembled monolayer (SAM) of amino-terminated moieties. In terms of the structure shown in FIG. 3, wherein CNT attraction material 30 adheres only to the substrate 12.
be activated before the deposition of the solution-suspended CNTs. To ensure good alignment of CNTs, it is desirable to activate the voltage source before the deposition of the solution-suspended CNTs.

In terms of the APTES monolayer, when it comes into contact with a silicon oxide surface (i.e., the surface of a typical substrate), it orientates itself through a self-assembly process so that the amino (—NH2) head group is pointing away from the surface of the substrate. Several different reactions resulting in different anchoring mechanisms can occur when APTES comes into contact with carbonyl (—COO) and hydroxyl (—OH) groups on the sidewall surface of CNTs. For example, with the correct selection of CNT processing and monolayer selection, a hydrogen bond forms between the monolayer and the carbonyl/hydroxyl group in the sidewall of the CNT. The carbonyl and hydroxyl groups on the nanotube surface contain a partially negative charge, while the amino head-group on the APTES is partially positive. Thus, the charges will attract, and an electrostatic bond can form. Specifically, the electron from the APTES headgroup is partially shared with the carbonyl and/or hydroxyl group on the CNT’s surface. Covalent bonds could also be created by performing an aminalysis reaction so that the carbonyl groups will form an amide (—COONH—) linkage with the monolayer, although this reaction would require the use of a catalyst.

As mentioned above, the monolayer does not need to be APTES. Any monolayer that would react with the carbonyl/hydroxyl groups on the CNT sidewall could be selected. Examples include monolayers that have a hydroxyl head-group (e.g., hydrogen bonding with the carbonyl groups and some with the hydroxyl groups) or a carbonyl head-group (e.g., more hydrogen bonding and esterification with the hydroxyl side groups could be performed to create covalent bonds, i.e., —COOC— bond). Also, choosing monolayers that have no reactive head-groups (e.g., octadecyltrichlorosilane or OTS) can be used to “shield” the surface from nanotube attachment. Additionally, the carbonyl/hydroxyl groups on the CNT sidewalls can be modified directly to enhance or prohibit their attachment to surfaces. For example, modifying a CNT so that the sidewall thereof is functionalized with a thiol group (—SH) would cause it to attach to a gold surface.

With additional reference now to FIG. 4, the sequence of steps used in the present invention (to create the structure shown in FIG. 3) are characterized in schematic form with a brief description thereof being provided in the corresponding box of the flowchart that is beside the description. For simplicity, a side view of only the relevant portion of apparatus 310 is shown at each step of the sequence.

At step 100, apparatus 310 is prepared for processing such that electrodes 20 and 22 are placed on substrate 12 with gap 24 defined therebetween. Once CNT attraction material 30 has been deposited in its desired location(s) at step 102, voltage source 18 is activated at step 104 so that an electric field is generated between electrodes 20 and 22 and across CNT attraction material in gap 24 as indicated by arrow 40. To insure good alignment of CNTs 32 falling between electrodes 20 and 22, it is suggested that voltage source 18 be activated before the deposition of the solution-suspended CNTs 32 at step 106. However, for some applications it may be desirable to activate voltage source 18 at the same time as, or just after, the deposition of the solution-suspended CNTs 32. Note that the direction of electric field 40 depends on the polarity of the electric potentials applied to alignment electrodes 20 and 22.

Next, at step 106, a quantity of CNTs 32 suspended in a carrier liquid solution 34 are deposited on apparatus 310 on and around CNT attraction material 30. Carrier liquid solution 34 is chosen so that the CNTs do not clump together. CNTs tend to clump together in solution due to strong van der Waals forces between individual CNTs. These forces are directly related to the size of the CNTs as well as the distance therebetween. The best solvent to disperse different CNTs also depends on the origin of the CNTs (e.g., vendor, batch or lot, etc.) and how the CNTs have been processed (e.g., cut with nitric acid to form functionalized sidewalls, purified, etc.). Given these variables, several different solvents may be used, such as toluene, n-methylpyrrolidone (NMP), dichloromethane (DCM), dimethylformamide (DMF), and even water that contains various surfactants (e.g., Triton X-100, sodium dodecyl sulfate, and others as would be well understood in the art). In general, the carrier liquid should minimize van der Waals forces between the CNTs suspended therein. Furthermore, when mixing the CNTs in the carrier liquid, ultrasonic energy can be used to help disperse the CNTs therein.

By virtue of this process, those of the solution-suspended CNTs that come into contact with CNT attraction material 30 (i) already have their tube axis 32A substantially aligned with the direction of electric field 40 as illustrated in FIG. 3, and (ii) adhere thereto in an aligned fashion by means of hydrogen bonding with the sidewall of CNTs 32. After a brief period of time (e.g., ranging from tens of seconds to several minutes with CNT densities being proportional to exposure time), electric field 40 is removed as well as any remaining liquid solution and CNTs not adhered to CNT attraction material 30, thereby leaving CNTs 32 aligned and adhered on CNT attraction material 30 as shown in FIG. 3.

Removal of the liquid carrier and CNTs suspended therein can simply involve blowing (as indicated by arrow 50 in step 108) of an inert gas such as nitrogen across the surface of apparatus 310 (with CNT attraction material 30 and CNTs 32 deposited thereon) until dry. To assure the removal of any CNTs 32 left in areas other than on CNT attraction material 30, additional processing can be implemented at step 110. Specifically, a rinse liquid 60 (e.g., n-methylpyrrolidone) is washed over the apparatus as it is vibrated (e.g., sonification by acoustic wave energy 62) thereby causing the non-aligned ones of CNTs 32 to become suspended in rinse liquid 60. An inert gas (e.g., nitrogen) is then used to blow off the rinse liquid and suspended CNTs as indicated by arrow 64. As a result, the structure shown in FIG. 3 is achieved. The embodiment provides for the controlled deposition and alignment of CNTs such that their electrical conductive properties can be exploited.
The embodiment of Fig. 1 can utilize the teachings of U.S. Patent application Ser. No. 10/730,188 to position CNT-based conductors 31 such that they are coupled on one and 31A to alignment electrode 20 and extend away therefrom in a spaced-apart fashion to second free end 31B. For example, by applying an electric field across alignment electrodes 20 and 22 (with CNTs 32 deposited only in the vicinity of one alignment electrode 20), CNTs 32 will align themselves (in the plane of electrode 20) with the electric field lines extending out from and substantially perpendicular to the edges of electrode 20. The length of CNT-based conductors 31 can be controlled/optimized for a particular light sensor by controlling (i) the lengths of CNTs 32, and/or (ii) the length of time that the alignment electric field is applied to the alignment electrodes 20 and 22. For example, if the alignment electric field is applied very briefly, each of CNT-based conductors might comprise a single CNT 32.

As mentioned previously, electron transfer toward or away from electrode 20 increases with the amount of light impinging on light sensor 10. Because electrons must transfer between semiconductor base 15 and electrode 20, insulating layer 17 must support such electron transfer. This support can be facilitated by selecting the proper thickness for insulating layer 17 and/or by the localized breakdown of layer 17 at free ends 31B brought on by the process of CNT alignment. That is, the electric potential applied during the alignment process generates an enhanced electric field at free ends 31B owing to the small diameters of the CNTs 32. The increased electric field at free ends 31B breaks down CNT-based conductors 31 such that they are coupled on one end 31-4 and the other end 31A to alignment electrode 20/CNT-based conductors 31 assembly is represented generically by reference numeral 210. While assembly 210 is represented for clarity of illustration as being circular in shape, assembly 210 may comprise a line electrode as shown in Fig. 6A, a circular electrode as shown in Fig. 6B, a rectangular electrode as shown in Fig. 6C, or any other shape. Further, any combination of electrode shapes (circular and line, line and rectangular, line, circular, and rectangular, etc.) could be used to construct such a sensing array.

Each assembly 210 is uniquely addressable and can have its electron transfer amounts detected or measured by addressing measurement device 36. That is, measurement device 236 functions as an individual measuring device (analogous to measurement devices 34 described earlier) for each assembly 210.

Although only a few exemplary embodiments of this invention have been described in detail above, those skilled in the art will readily appreciate that many modifications are possible in the exemplary embodiments without materially departing from the novel teachings and advantages of this invention. Accordingly, all such modifications are intended to be included within the scope of this invention as defined in the following claims. In the claims, means-plus-function and step-plus-function clauses are intended to cover the structures or acts described herein as performing the recited function and not only structural equivalents, but also equivalent structures. Thus, although a nail and a screw may not be structural equivalents in that a nail employs a cylindrical surface to secure wooden parts together whereas a screw employs a helical surface, in the environment of fastening wooden parts, a nail and a screw may be equivalent structures.

What is claimed is:

1. A light sensor comprising: a substrate comprising a base made from a semi-conductive material and a layer of an electrically non-conductive material on a surface of said base; at least one alignment electrode on said base; a plurality of carbon nanotube (CNT)-based conductors on said layer and distributed in a spaced apart fashion about a periphery of said at least one alignment electrode with each of said plurality of CNT-based conductors coupled on one end thereof to said at least one alignment electrode and extending away from said at least one alignment electrode to terminate at a second end thereof, each of said plurality of CNT-based conductors comprising at least one CNT; and means, coupled to at least one alignment electrode and said at least one gate electrode, for detecting a quantity indicative of CNT-based conductors, and means, coupled to at least one alignment electrode and said at least one gate electrode, for detecting a quantity indicative of CNT-based conductors, wherein said electron transfer is indicative of light impinging on said plurality of CNT-based conductors.

2. A light sensor as in claim 1 wherein said semi-conductive material is silicon doped with at least one impurity.

3. A light sensor as in claim 2 wherein said at least one impurity is selected to make said semi-conductive material a p-type semiconductor.

4. A light sensor as in claim 2 wherein said at least one impurity is selected to make said semi-conductive material an n-type semiconductor.
5. A light sensor as in claim 1 wherein said electrically non-conductive material is selected from the group consisting of silicon dioxide and silicon nitride.

6. A light sensor as in claim 1 wherein said semi-conductive material is silicon based and said electrically non-conductive material is silicon dioxide.

7. A light sensor as in claim 1 wherein each said CNT is a single-wall CNT.

8. A light sensor as in claim 1 wherein said detecting means comprises a current meter.

9. A light sensor as in claim 1 wherein said detecting means comprises a voltmeter.

10. A light sensor as in claim 1 wherein said at least one alignment electrode comprises at least one strip of electrically conductive material converging to at least one pointed tip.

11. A light sensor comprising:
   a substrate comprising a base made from a silicon-based material with a layer of silicon dioxide on a surface of said base;
   at least one alignment electrode on said layer;
   a plurality of carbon nanotube (CNT)-based conductors on said layer and distributed in a spaced apart fashion about a periphery of said at least one alignment electrode with each of said plurality of CNT-based conductors coupled on one end thereof to said at least one alignment electrode and extending away from said at least one alignment electrode to terminate at a second end thereof, each of said plurality of CNT-based conductors comprising at least one CNT;
   a gate electrode on said layer and spaced apart from said second end of each of said plurality of CNT conductors; and
   means, coupled to said at least one alignment electrode and said gate electrode, for detecting a quantity indicative of electron transfer along said plurality of CNT conductors wherein said electron transfer is indicative of an amount of light impinging on said plurality of CNT conductors.

12. A light sensor as in claim 11 wherein said detecting means comprises a voltmeter.

13. A light sensor as in claim 11 wherein said detecting means comprises a current meter.

14. A light sensor as in claim 11 wherein said at least one alignment electrode comprises at least one strip of electrically conductive material converging to at least one pointed tip.

15. A light sensor comprising:
   a substrate comprising a base made from a semi-conductive material and a layer of an electrically non-conductive material on a surface of said base;
   at least one alignment electrode on said layer;
   a plurality of carbon nanotube (CNT) conductors on said layer and distributed in a spaced apart fashion about a periphery of said at least one alignment electrode with each of said plurality of CNT conductors coupled on one end thereof to said at least one alignment electrode and extending away from said at least one alignment electrode to terminate at a second end thereof, each of said plurality of CNT conductors comprising at least one CNT;
   a gate electrode on said layer and spaced apart from said second end of each of said plurality of CNT conductors; and
   means, coupled to said at least one alignment electrode and said gate electrode, for detecting a quantity indicative of electron transfer along said plurality of CNT conductors wherein said electron transfer is indicative of an amount of light impinging on said plurality of CNT conductors.

16. A light sensor as in claim 15 wherein said semi-conductive material is silicon doped with at least one impurity.

17. A light sensor as in claim 16 wherein said at least one impurity is selected to make said semi-conductive material a p-type semiconductor.

18. A light sensor as in claim 16 wherein said at least one impurity is selected to make said semi-conductive material an n-type semiconductor.

19. A light sensor as in claim 15 wherein said electrically non-conductive material is selected from the group consisting of silicon dioxide and silicon nitride.

20. A light sensor as in claim 15 wherein said detecting means comprises a current meter.

21. A light sensor as in claim 16 wherein said detecting means comprises a current meter.

22. A light sensor as in claim 16 wherein said at least one alignment electrode comprises at least one strip of electrically conductive material converging to at least one pointed tip.

23. A light sensor comprising:
   a substrate comprising a base made from a silicon-based material with a layer of silicon dioxide on a surface of said base;
   at least one alignment electrode on said layer;
   a plurality of carbon nanotube (CNT) conductors on said layer and distributed in a spaced apart fashion about a periphery of said at least one alignment electrode with each of said plurality of CNT conductors coupled on one end thereof to said at least one alignment electrode to terminate at a second end thereof, each of said plurality of CNT conductors comprising at least one CNT;
   a gate electrode on said layer and spaced apart from said second end of each of said plurality of CNT conductors and said gate electrode, for detecting a quantity indicative of electron transfer along said plurality of CNT conductors wherein said electron transfer is indicative of an amount of light impinging on said plurality of CNT conductors.

24. A light sensor as in claim 23 wherein said detecting means comprises a voltmeter.

25. A light sensor as in claim 23 wherein said detecting means comprises a current meter.

26. A light sensor as in claim 23 wherein said at least one alignment electrode comprises at least one strip of electrically conductive material converging to at least one pointed tip.
27. A light sensor comprising:
a substrate comprising a base made from a semi-conduc-
tive material and a layer of an electrically non-conduc-
tive material on a surface of said base;
at least one electrode/carbon nanotube (CNT)-based con-
ductor assembly positioned on said layer, each elec-

trode/CNT-based conductor assembly comprising at
least one alignment electrode and a plurality of CNT-

based conductors positioned on said layer, said plural-
ity of CNT-based conductors distributed in a spaced
apart fashion about a periphery of said alignment
electrode with each of said plurality of CNT-based
conductors coupled on one end thereof to said align-
ment electrode and extending away from said align-
ment electrode to terminate at a second end thereof,
each of said plurality of CNT-based conductors com-
prising at least one CNT;
at least one gate electrode on said layer and spaced apart
from said second end each of each of said plurality of
CNT-based conductors;
said electrically non-conductive material being config-
ured to support electron transfer there through so as to
permit the transfer of electrons between said semi-
conductive material and said at least one electrode/CNT-
based conductor assembly; and
means, coupled to said at least one electrode/CNT-based
conductor assembly and said at least one gate electrode,
for detecting a quantity indicative of electron transfer
for each electrode/CNT-based conductor assembly,
wherein said electron transfer is indicative of an
amount of light impinging each electrode/CNT-based
conductor assembly.

28. A light sensor as in claim 27 wherein said semi-
conductive material is silicon doped with at least one
impurity.

29. A light sensor as in claim 28 wherein said at least one
impurity is selected to make said semi-conductive material
a p-type semiconductor.

30. A light sensor as in claim 28 wherein said at least one
impurity is selected to make said semi-conductive material
an n-type semiconductor.

31. A light sensor as in claim 27 wherein said electrically
non-conductive material is selected from the group consist-
ing of silicon dioxide and silicon nitride.

32. A light sensor as in claim 27 wherein said semi-
conductive material is silicon based and said electrically
non-conductive material is silicon dioxide.

33. A light sensor as in claim 27 wherein each said CNT
is a single-wall CNT.

34. A light sensor as in claim 27 wherein said detecting
means comprises a voltmeter.

35. A light sensor as in claim 27 wherein said detecting
means comprises a current meter.

36. A light sensor as in claim 27 wherein said at least one
alignment electrode comprises at least one strip of electric-
ally conductive material converging to at least one pointed
tip.

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